



DIA Korea RMP Forum

23 October, 2026

Central Post Tower, Seoul, Korea

Application Form for Sponsorship & Exhibition

Please select your preferred options and submit this form to korea@diaglobal.org

For further details, please feel free to contact the DIA Korea team.

Applicant Information

Contact Person			
First Name		Last Name	
Department/Team		Position/Title	
Contact Number		E-mail	
Company Name (English)			
Company Address (English)			
Postal code		Country	

Sponsorship

Category		Price
Exhibition	Exhibition Booth	☐ USD \$2,000
Advertisement in the program book	Cover page	☐ USD \$1,500
	Inside page	☐ USD \$1,300
Speaking Opportunity	Innovation Hub	☐ USD \$2,500
On-Site Visibilities	Projector Promotion Opportunity	☐ USD \$1,300
Digital Marketing	Email Bottom Banner	☐ USD \$1,800
	E-blast to DIA Korea contact lists	☐ USD \$3,200
Total Amount		

Payment

Payment			
☐ VISA	☐ MASTER	☐ AMEX	☐ BANK TRANSFER
Card number			
Card holder name			
Exp. (mm/yy)			

**You will receive an invoice with bank information detail by email after registration completion.
All local and overseas charges incurred for the bank transfer must be borne by payer.**

Date (DD/MM/YYYY) COMPANY NAME (SIGNATURE)